

# STN5PF02V

## P-channel 20V - 0.065Ω - 4.2A - SOT-223 2.5V - Drive STripFET™ II Power MOSFET

## **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	۱ <sub>D</sub>
STN5PF02V	20V	<0.080Ω	4.2A

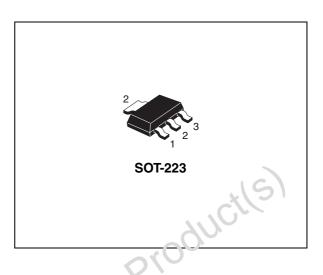
- Ultra low threshold gate drive (2.5V)
- Standard outline for easy automated surface mount assembly

## Description

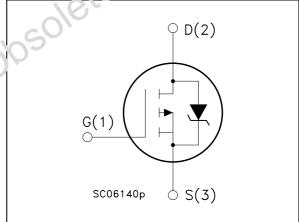
This Power MOSFET is the latest development of STMicroelectronics unique "single feature size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely extremely low on-resistance when driven at 2.5V.

## Applications

Switching application



## Internal schematic diagram



# Order codes

$\bigcirc$	Part number	Marking	Package	Packaging
	STN5PF02V	N5PF02V	SOT-223	Tape & reel

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## **Electrical ratings** 1

Table 1. Absolute maximum	ratings
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Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage ( $V_{GS} = 0$ )	20	V
V <sub>GS</sub>	Gate- source voltage	± 8	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	4.2	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	2.6	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	17	Α
P <sub>TOT</sub>	Total dissipation at $T_{C} = 25^{\circ}C$	2.5	W
T <sub>j</sub> T <sub>stg</sub>	Max. operating junction temperature Storage temperature	-55 to 150	°C

1. Pulse width limited by safe operating area

For the p-channel Power MOSFET actual polarity of voltages and current has Note: to be reversed prodi

#### Table 2. **Thermal resistance**

Symbol	Parameter	Max value	Unit
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pc board	50	°C/W
Rthj-amb	Thermal resistance junction-ambient	90	°C/W

1. When mounted on FR-4 board of 1inch<sup>2</sup> pad, 2oz Cu and tc< 10sec obsolete Product(S)

## **Electrical characteristics** 2

(T<sub>CASE</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0	20			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = Max rating V <sub>DS</sub> = Max rating,@125°C			1 10	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	$V_{GS} = \pm 8V$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.45			V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 4.5V, I_D = 2.1A$ $V_{GS} = 2.5V, I_D = 2.1A$		0.065 0.085	0.080 0.10	Ω Ω
Table 4.	Dynamic			.60	5	
			1.1			

#### Table 3. **On/off states**

#### Table 4. Dynamic

i abie ii	<b>- ya</b>					
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
9 <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>DS</sub> = 15V <sub>,</sub> I <sub>D</sub> = 2.5A		6.6		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 15V, f = 1 MHz, V <sub>GS</sub> = 0		412 179 42.5		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 10V, I_D = 4.2A,$ $V_{GS} = 2.5V$ (see Figure 13)		4.5 0.73 1.75	6	nC nC nC

Je duratio 1. Pulsed: Pulse duration = 300  $\mu s,$  duty cycle 1.5 %

	•					
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-on delay time Rise time Turn-off-delay time Fall time	$V_{DD} = 10V, I_D = 2.1A$ $R_G = 4.7\Omega, V_{GS} = 2.5V$ (see Figure 12)		11 47 38 20		ns ns ns ns

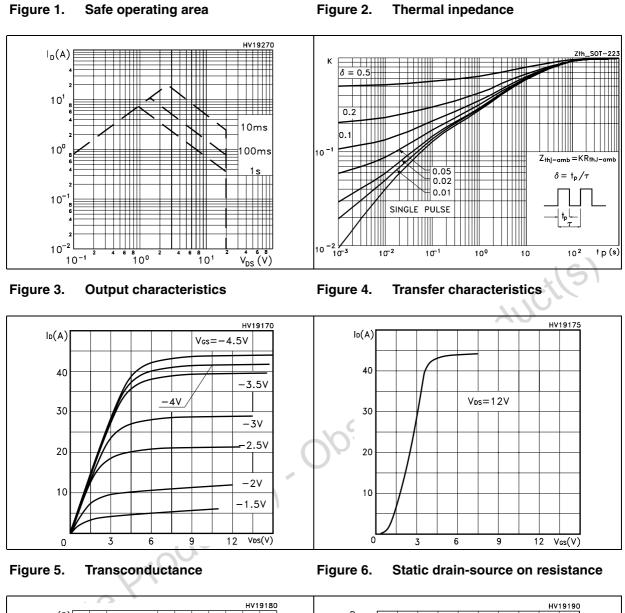
Switching times Table 5.

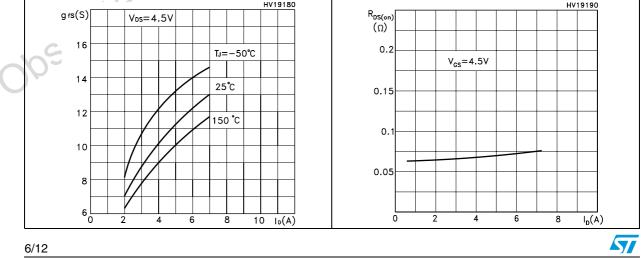
#### Source drain diode Table 6.

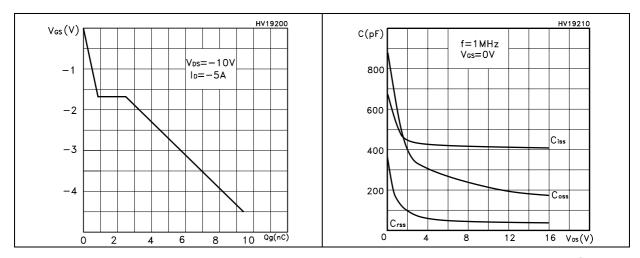
Table 0.	Source drain diode					
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				4.2	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				17	A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 4.2A, V_{GS} = 0$			1.2	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD}$ = 4.2A, di/dt=100A/µs,		32		ns
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD} = 16V, T_j = 150^{\circ}C$		12.8	19	nC
IRRM	Reverse recovery current	(see Figure 14)		0.8		Α
2. Pulsed: F	Reverse recovery charge Reverse recovery current Ath limited by safe operating area Pulse duration = 300 µs, duty cycle 1.9	osolete Pr				

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## 2.1 Electrical characteristics (curves)







#### Gate charge vs gate-source voltage Figure 8. Figure 7. **Capacitance variations**

Figure 9. vs temperature

Normalized gate threshold voltage Figure 10. Normalized on resistance vs. temperature

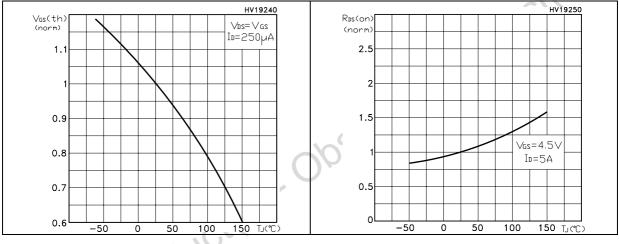
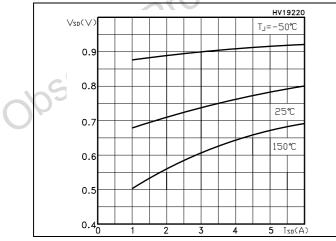


Figure 11. Source-drain diode forward characteristics





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## 3 Test circuit

Figure 12. Switching times test circuit for resistive load

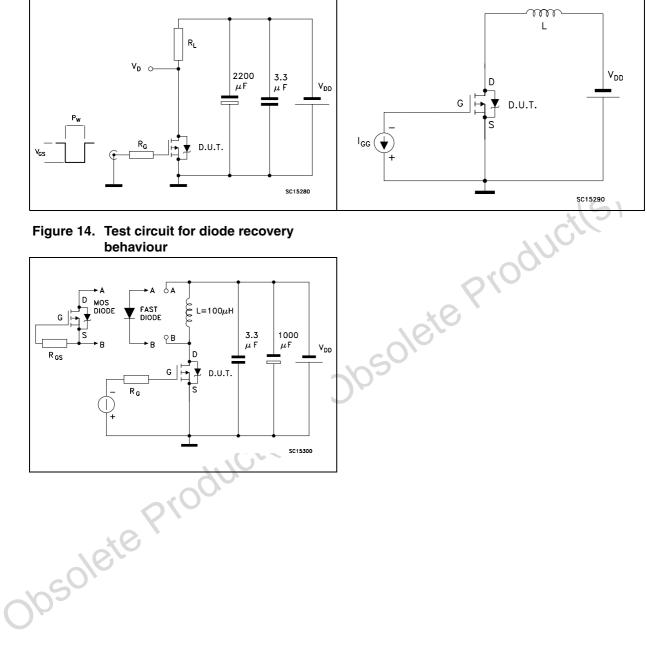


Figure 13. Gate charge test circuit

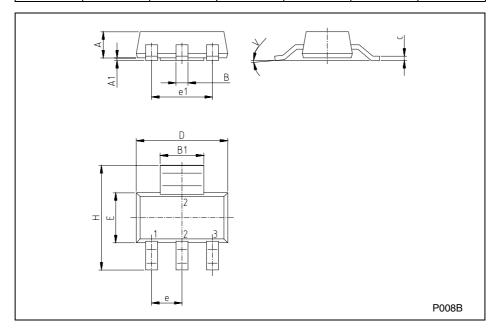
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

obsolete Product(s). Obsolete Product(s)

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SOT-223 MECHANICAL DATA						
DIM.		mm			inch	
Dim	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			1.80			0.071
В	0.60	0.70	0.80	0.024	0.027	0.031
B1	2.90	3.00	3.10	0.114	0.118	0.122
с	0.24	0.26	0.32	0.009	0.010	0.013
D	6.30	6.50	6.70	0.248	0.256	0.264
е		2.30			0.090	
e1		4.60			0.181	
Е	3.30	3.50	3.70	0.130	0.138	0.146
Н	6.70	7.00	7.30	0.264	0.276	0.287
V			10 <sup>°</sup>			10 <sup>°</sup>
A1		0.02				





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## 5 Revision history

Table 7.	Revision	history
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Date	Revision	Changes
20-Jun-2005	1	First release
13-Dec-2005	2	Final version
04-Aug-2006	3	New template

obsolete Product(s). Obsolete Product(s)



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